DOCUMENT: M20182 REV LETTER: K PAGE NO: 1 OF 2 REV DATE: 2021-09-19 PART NUMBER:

Polymer PTC Devices

Room 203, East a, Zhejiang University Science and Technology Park, No. 525, Xixi Road, Xihu District, Hangzhou

c **R**us

200mA/24V

4V

Surface mount fuses Tel: 86-571- 87006810 E-mail: sales@dowosemi.com

Fax: 86-571-87671286

Http:www.dowosemi.cn



Features

- Small size of 1206
- Lead-free、halogen-free and compliant with the European Union RoHS Directive 2011/65/EU
- Fast tripping resettable circuit protection
- Surface mount packaging for automated assembly
- Agency Recognition: UL

Product Dimensions (mm)

Part number	Α	В	С	D	E	Part	
	Тур.	Тур.	Тур.	Тур.	Тур.	- marking	C
200mA/24V	3.20 ± 0.30	1.60 ± 0.20	0.60 ± 0.25	0.60 ± 0.35	0.30 ± 0.20	С	

Electrical Characteristics

Part number	Ін	lτ	V _{max}	Imax	Ttrip		Pd typ	R _{min}	R _{1max}
	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	(Ω)	(Ω)
200mA/24V	0.20	0.40	24	40	8.0	0.05	0.6	0.60	2.50

 $I_{\text{H}}\text{=}\text{Hold}$ current: maximum current at which the device will not trip at 25 $^\circ\!\!\!\mathrm{C}$ still air.

IT=Trip current: minimum current at which the device will always trip at 25 $^\circ\!\!\mathbb{C}$ still air.

V_{max}=Maximum voltage device can withstand without damage at rated current.

 $I_{\text{max}}\text{=}\text{Maximum}$ fault current device can withstand without damage at rated voltage.

Ttrip=Maximum time to trip(s) at assigned current.

Pdtyp=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

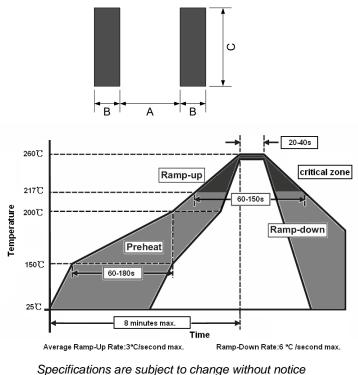
R_{min}=Minimum device resistance at 25 ℃ prior to tripping.

R1max=Maximum device resistance measured in the nontripped state 1 hour post reflow.

Thermal Derating

200mA/24V	Maximum ambient operating temperature(℃)									
	-40	-20	0	20	25	40	50	60	70	85
Hold Current (A)	0.31	0.26	0.22	0.21	0.20	0.18	0.16	0.15	0.13	0.07
Trip Current (A)	0.65	0.54	0.45	0.42	0.40	0.36	0.32	0.29	0.25	0.12

Solder Reflow Recommendations



Solder Pad Layouts

Part number	Α	В	С	
	(mm)	(mm)	(mm)	
200mA/24V	1.80	1.00	1.80	

* Recommended reflow methods: IR, Vapor phase, and hot air oven.

* Devices can be cleaned using standard industry methods and solvents.

Notes:

• If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

• Devices are not designed to be wave soldered to the bottom side of the board.

Package Information

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.

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PART NU	MBER:	Surface mount fuses	Tel: 86-571- 87006810	Fax: 86-571-87671286		
200m/	A/24V		E-mail: <u>sales@dowosemi.com</u>	Http: <u>www.dowosemi.cn</u>		
			SMD PTC 使用注意	事项		
			autions for SMD PT			
1.			下使用,超出 PTC 最大电压或	或最大电流规格值的操作,可能会导致 PTC 出	出现电	
	弧,阻值升高 Operation bey		or current may result in dev	vice damage, PTC arcing, resistance increas	sina	
	even burning.		or current may result in dev	nee damage, i to arcing, resistance increas	ing,	
2.	规格书所规定 流条件下保持	1小时。该电流并不是该型	型号 PTC 能够适用的长期充成			
	reflow welding	. PTC can hold 1 hour at		et is the conventional performance of after on different temperatures. But this current is no		
3.	规格书所规定	的电阻以及电气特性,均是		一次回流焊之后的测试。如果客户有二次回流		
				sheet are based on the test tested on the spe eds to be verified because above parameters		
			cesses, like twice soldering			
4.	PTC is therma	al sensitive device. It is rec		热源元件,尽量减少外部热源的影响。 urce devices be designed to around in order t	to	
5.	PTC 贴片产品			焊接工艺可参考维安推荐的回流焊曲线。如果 PTC,禁止对线路板其他元件或端子返工时使		
		-		Please refer to the Wayon recommended		
	-	•		nded value, the PTC might be damaged. Ma	anual	
6.				ework of other components on the board. 化胶粘剂、硅胶,需要对注塑料胶料等材料牌	1	
0.	及应用参数() When assemb	如温度、时间等)进行验证 bling and applying PTC, th	E,以确保产品及工艺的匹配 e material mark and applica	性,确认不会影响 PTC 性能之后方可使用。 tion parameters (Temperature, Time, and etc buld be verified to ensure the consistency bet	c.) of	
7.	the products a PTC 贴装或使 溶剂的适用性	nd the processing techno 用过程中,不建议使用洗机,确认不会影响 PTC 性能	logy. Only it is confirmed tha 板水或其他清洗剂进行清洗。 之后方可使用。已知对 PTC	the consistency bersule the consistency berst would not influent PTC then can be used. 如必须使用,需要验证各类清洗剂、洗板水口 有影响的化学药品包括但不仅限于醚类、苯类 于敞开的环境中至少 24 小时,将残留的溶剂	以及 类、酮	
	When assemb it is required, i confirmed that	t is necessary to verify the t they will not affect the P	e applicability of various clea IC performance. Chemicals	ing washer water or other cleaner to clean P iner, washer water and solvents, it is also that are known to have an effect on PTC incl ounds such as ethers, benzenes, ketones, ar	lude,	
				to volatilize the residual solvents.		
8.				本体,以免引起 PTC 性能衰减。 g assembling process to avoid the performan	ce	
9.	在产品应用中 个月,则需密	闭保存,可避免 PTC 长时	间暴露于空气环境中。	豆的时间内完成,如贴装与注塑打胶时间间隔起		
	time lag betwe			the injection or glue as soon as possible. IF eds to reserve in the closed space so as to a		
10.	PTC 为自恢复	保护元件,但并不能当做	开关使用,重复多次的保护会			
11.	PTC 在充电线	端应用中,建议使用 PP 刻	类材料做内膜,禁止使用 TP I	hold current will reduced after repeated trippi E 类与 PVC 类等材料做内膜。 nded as inner membrane, TPE or PVC mate	-	
10	are prohibited			装破损的,立即将产品隔离处理;使用时如有		
12.	料, 需恢复之	前包装状态,做密封保存		表w须的,立时行了 面隔齿处理; 使用时如有 aged package is found by customer, please is		
			k it as the previous package			